

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
30	0.037 at V _{GS} = 10 V	15 ^d	21.7		
30	0.055 at V _{GS} = 4.5 V	15 ^d	21.7		

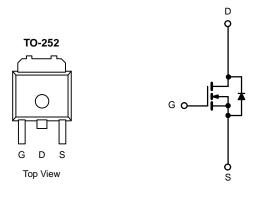
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





- Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	$T_C = 25 ^{\circ}C$, unless other	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	30	V		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	1-	15 ^d		
Continuous Diam Current (1) = 130 °C)	T _C = 70 °C	I _D	15 ^d	۸	
Pulsed Drain Current		I _{DM}	100	А	
Avalanche Current		I _{AS}	40		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	80	mJ	
M	T _C = 25 °C	Б	59.5 ^b	W	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_D$	2.7		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	46	°C/W		
Junction-to-Case (Drain)	R _{thJC}	2.1	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 125 °C			50		
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain Source On State Resistance	В	V _{GS} = 10 V, I _D = 12 A		0.037		0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.055		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		110		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2780		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}$		641			
Reverse Transfer Capacitance	C _{rss}			260			
Total Gate Charge ^c	Q_g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		44	66		
Total Gate Charge		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 10 A		21.7	32.6	nC	
Gate-Source Charge ^c	Q _{gs}			7			
Gate-Drain Charge ^c	Q_{gd}			6.7			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		9	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings a	nd Characteris	stics T _C = 25 °C ^b					
Continuous Current	I _S	I _S			50	۸	
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V_{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		2	3	Α	
Reverse Recovery Charge	Q _{rr}			34	51	nC	

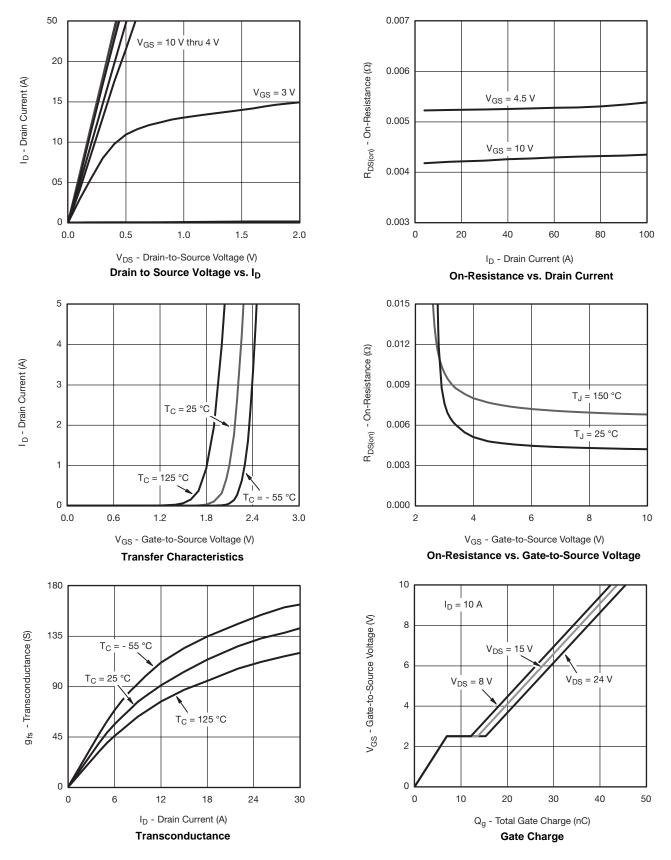
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

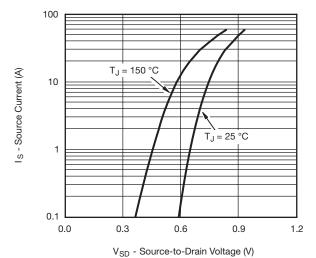


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

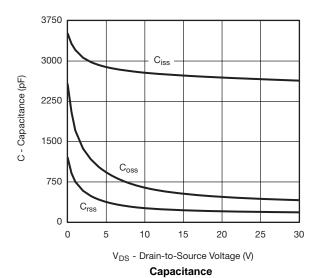




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

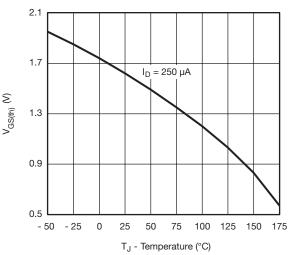


Source-Drain Diode Forward Voltage

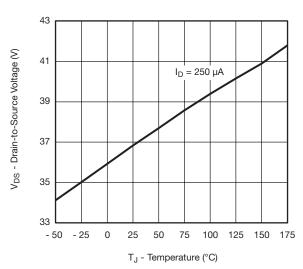


2.0 I_D = 10 A 1.7 V_{GS} = 10 V V_{GS} = 4.5 V V_{GS} = 4.5 V 0.8 0.5 -50 -25 0 25 50 75 100 125 150 175

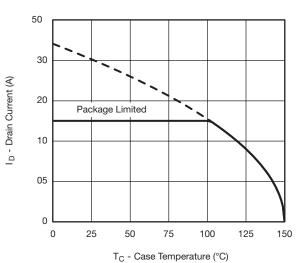
 $\label{eq:TJ-Junction} T_{J} \text{ - Junction Temperature (°C)}$ On-Resistance vs. Junction Temperature



Threshold Voltage



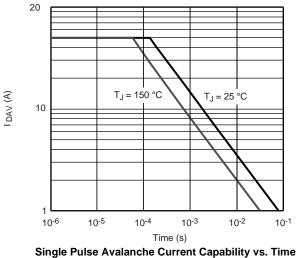
Drain Source Breakdown vs. Junction Temperature

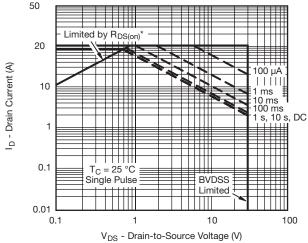


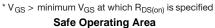
Current Derating

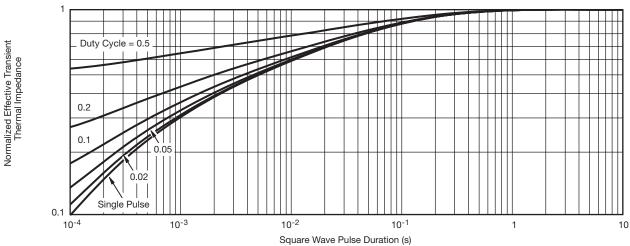


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









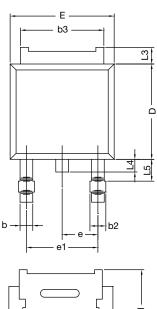
Normalized Thermal Transient Impedance, Junction-to-Case

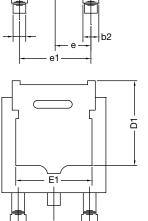
服务热线:400-655-8788

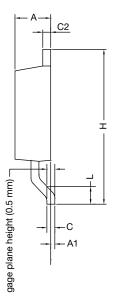
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TO-252AA CASE OUTLINE







	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12					

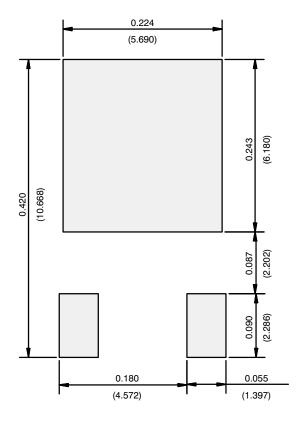
DWG: 5347

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

服务热线:400-655-8788

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